



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



## Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <http://www.nxp.com>, <http://www.philips.com/> or <http://www.semiconductors.philips.com/>, use <http://www.nexperia.com>

Instead of [sales.addresses@www.nxp.com](mailto:sales.addresses@www.nxp.com) or [sales.addresses@www.semiconductors.philips.com](mailto:sales.addresses@www.semiconductors.philips.com), use [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com) (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © **Nexperia B.V. (year). All rights reserved.**

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

# 74AHC86-Q100; 74AHCT86-Q100

Quad 2-input EXCLUSIVE-OR gate

Rev. 1 — 5 June 2013

Product data sheet

## 1. General description

The 74AHC86-Q100; 74AHCT86-Q100 are high-speed Si-gate CMOS devices and are pin compatible with Low-power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74AHC86-Q100; 74AHCT86-Q100 provides a 2-input exclusive-OR function.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and from  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$
- Balanced propagation delays
- All inputs have a Schmitt-trigger action
- Inputs accept voltages higher than  $V_{CC}$
- For 74AHC86-Q100 only: operates with CMOS input levels
- For 74AHCT86-Q100 only: operates with TTL input levels
- ESD protection:
  - ◆ MIL-STD-883, method 3015 exceeds 2000 V
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V ( $C = 200\text{ pF}$ ,  $R = 0\ \Omega$ )
- Multiple package options

## 3. Ordering information

Table 1. Ordering information

| Type number                       | Package   |          |   |          |
|-----------------------------------|---|----------|---|----------|
|                                   | Temperature range   | Name     | Description   | Version  |
| 74AHC86D-Q100<br>74AHCT86D-Q100   | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | SO14     | plastic small outline package; 14 leads;<br>body width 3.9 mm   | SOT108-1 |
| 74AHC86PW-Q100<br>74AHCT86PW-Q100 | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | TSSOP14  | plastic thin shrink small outline package; 14 leads;<br>body width 4.4 mm   | SOT402-1 |
| 74AHC86BQ-Q100<br>74AHCT86BQ-Q100 | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | DHVQFN14 | plastic dual in-line compatible thermal enhanced<br>very thin quad flat package; no leads; 14 terminals;<br>body $2.5 \times 3 \times 0.85\text{ mm}$ | SOT762-1 |



### 4. Functional diagram

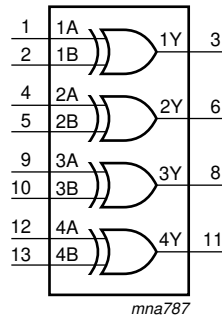


Fig 1. Logic symbol

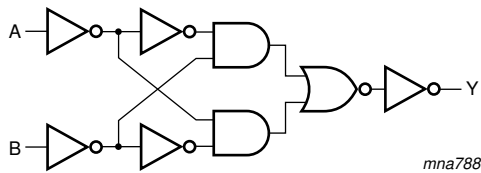


Fig 2. Logic diagram (one gate)

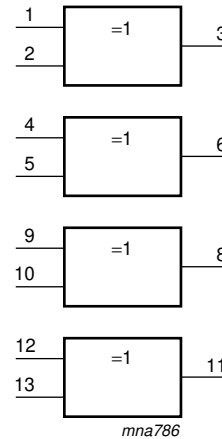
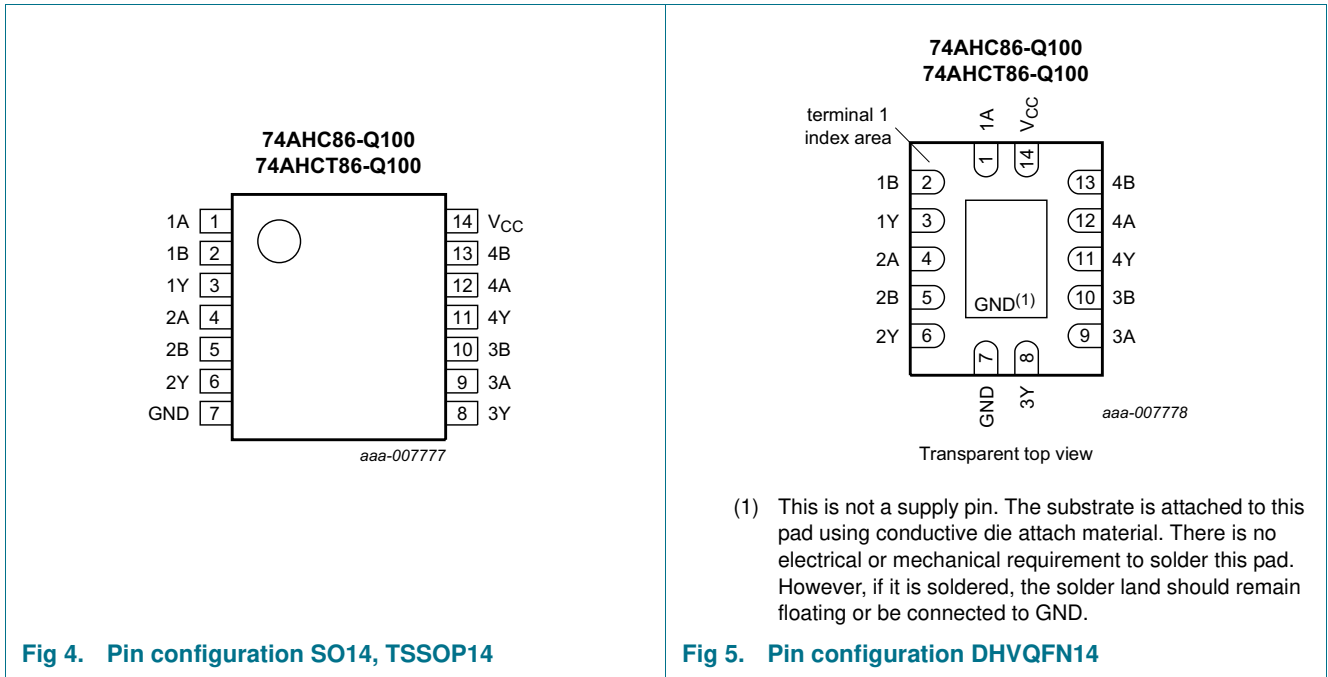


Fig 3. IEC logic symbol

## 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

Table 2. Pin description

| Symbol          | Pin          | Description    |
|-----------------|--------------|----------------|
| 1A to 4A        | 1, 4, 9, 12  | data input     |
| 1B to 4B        | 2, 5, 10, 13 | data input     |
| 1Y to 4Y        | 3, 6, 8, 11  | data outputs   |
| GND             | 7            | ground (0 V)   |
| V <sub>CC</sub> | 14           | supply voltage |

## 6. Functional description

Table 3. Function table<sup>[1]</sup>

| Input nA | Input nB | Output nY |
|----------|----------|-----------|
| L        | L        | L         |
| L        | H        | H         |
| H        | L        | H         |
| H        | H        | L         |

[1] H = HIGH voltage level;  
L = LOW voltage level.

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                               | Min     | Max  | Unit |
|-----------|-------------------------|--|---------|------|------|
| $V_{CC}$  | supply voltage          |  | -0.5    | +7.0 | V    |
| $V_I$     | input voltage           |  | -0.5    | +7.0 | V    |
| $I_{IK}$  | input clamping current  | $V_I < -0.5$ V                           | [1] -20 | -    | mA   |
| $I_{OK}$  | output clamping current | $V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V | [1] -   | ±20  | mA   |
| $I_O$     | output current          | $V_O = -0.5$ V to $(V_{CC} + 0.5$ V)     | -       | ±25  | mA   |
| $I_{CC}$  | supply current          |  | -       | 75   | mA   |
| $I_{GND}$ | ground current          |  | -75     | -    | mA   |
| $T_{stg}$ | storage temperature     |  | -65     | +150 | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to $+125$ °C          |         |      |      |
|           | SO14 package            |  | [2] -   | 500  | mW   |
|           | TSSOP14 package         |  | [3] -   | 500  | mW   |
|           | DHVQFN14 package        |  | [4] -   | 500  | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2]  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.

[3]  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

[4]  $P_{tot}$  derates linearly with 4.5 mW/K above 60 °C.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

Voltages are referenced to GND (ground = 0 V).

| Symbol              | Parameter                           | Conditions               | 74AHC86-Q100 |     |          | 74AHCT86-Q100 |     |          | Unit |
|---------------------|-------------------------------------|--------------------------|--------------|-----|----------|---------------|-----|----------|------|
|                     |                                     |                          | Min          | Typ | Max      | Min           | Typ | Max      |      |
| $V_{CC}$            | supply voltage                      |                          | 2.0          | 5.0 | 5.5      | 4.5           | 5.0 | 5.5      | V    |
| $V_I$               | input voltage                       |                          | 0            | -   | 5.5      | 0             | -   | 5.5      | V    |
| $V_O$               | output voltage                      |                          | 0            | -   | $V_{CC}$ | 0             | -   | $V_{CC}$ | V    |
| $T_{amb}$           | ambient temperature                 |                          | -40          | +25 | +125     | -40           | +25 | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 3.3$ V ± 0.3 V | -            | -   | 100      | -             | -   | -        | ns/V |
|                     |                                     | $V_{CC} = 5.0$ V ± 0.5 V | -            | -   | 20       | -             | -   | 20       | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

Voltages are referenced to GND (ground = 0 V).

| Symbol  | Parameter                 | Conditions   | 25 °C |     |      | -40 °C to +85 °C |      | -40 °C to +125 °C |      | Unit |
|---|---------------------------|--|-------|-----|------|------------------|------|-------------------|------|------|
|   |                           |  | Min   | Typ | Max  | Min              | Max  | Min               | Max  |      |
| <b>For type 74AHC86-Q100</b>                      |                           |  |       |     |      |                  |      |                   |      |      |
| V <sub>IH</sub>                                   | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V  | 1.5   | -   | -    | 1.5              | -    | 1.5               | -    | V    |
|   |                           | V <sub>CC</sub> = 3.0 V  | 2.1   | -   | -    | 2.1              | -    | 2.1               | -    | V    |
|   |                           | V <sub>CC</sub> = 5.5 V  | 3.85  | -   | -    | 3.85             | -    | 3.85              | -    | V    |
| V <sub>IL</sub>                                   | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V  | -     | -   | 0.5  | -                | 0.5  | -                 | 0.5  | V    |
|   |                           | V <sub>CC</sub> = 3.0 V  | -     | -   | 0.9  | -                | 0.9  | -                 | 0.9  | V    |
|   |                           | V <sub>CC</sub> = 5.5 V  | -     | -   | 1.65 | -                | 1.65 | -                 | 1.65 | V    |
| V <sub>OH</sub>                                   | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |       |     |      |                  |      |                   |      |      |
|   |                           | I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 2.0 V                                       | 1.9   | 2.0 | -    | 1.9              | -    | 1.9               | -    | V    |
|   |                           | I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 3.0 V                                       | 2.9   | 3.0 | -    | 2.9              | -    | 2.9               | -    | V    |
|   |                           | I <sub>O</sub> = -50 μA; V <sub>CC</sub> = 4.5 V                                       | 4.4   | 4.5 | -    | 4.4              | -    | 4.4               | -    | V    |
|   |                           | I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V                                      | 2.58  | -   | -    | 2.48             | -    | 2.40              | -    | V    |
| I <sub>O</sub> = -8.0 mA; V <sub>CC</sub> = 4.5 V | 3.94                      | -  | -     | 3.8 | -    | 3.70             | -    | V                 |      |      |
| V <sub>OL</sub>                                   | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |       |     |      |                  |      |                   |      |      |
|   |                           | I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 2.0 V  | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|   |                           | I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 3.0 V  | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|   |                           | I <sub>O</sub> = 50 μA; V <sub>CC</sub> = 4.5 V  | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|   |                           | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V                                       | -     | -   | 0.36 | -                | 0.44 | -                 | 0.55 | V    |
| I <sub>O</sub> = 8.0 mA; V <sub>CC</sub> = 4.5 V  | -                         | -  | 0.36  | -   | 0.44 | -                | 0.55 | V                 |      |      |
| I <sub>I</sub>                                    | input leakage current     | V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V                          | -     | -   | 0.1  | -                | 1.0  | -                 | 2.0  | μA   |
| I <sub>CC</sub>                                   | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 5.5 V | -     | -   | 2.0  | -                | 20   | -                 | 40   | μA   |
| C <sub>I</sub>                                    | input capacitance         |  | -     | 3.0 | 10   | -                | 10   | -                 | 10   | pF   |
| C <sub>O</sub>                                    | output capacitance        |  | -     | 4.0 | -    | -                | -    | -                 | -    | pF   |
| <b>For type 74AHCT86-Q100</b>                     |                           |  |       |     |      |                  |      |                   |      |      |
| V <sub>IH</sub>                                   | HIGH-level input voltage  | V <sub>CC</sub> = 4.5 V to 5.5 V   | 2.0   | -   | -    | 2.0              | -    | 2.0               | -    | V    |
| V <sub>IL</sub>                                   | LOW-level input voltage   | V <sub>CC</sub> = 4.5 V to 5.5 V   | -     | -   | 0.8  | -                | 0.8  | -                 | 0.8  | V    |
| V <sub>OH</sub>                                   | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V          |       |     |      |                  |      |                   |      |      |
|   |                           | I <sub>O</sub> = -50 μA  | 4.4   | 4.5 | -    | 4.4              | -    | 4.4               | -    | V    |
|   |                           | I <sub>O</sub> = -8.0 mA   | 3.94  | -   | -    | 3.8              | -    | 3.70              | -    | V    |
| V <sub>OL</sub>                                   | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V          |       |     |      |                  |      |                   |      |      |
|   |                           | I <sub>O</sub> = 50 μA   | -     | 0   | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|   |                           | I <sub>O</sub> = 8.0 mA  | -     | -   | 0.36 | -                | 0.44 | -                 | 0.55 | V    |

**Table 6. Static characteristics ...continued**  
 Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions  | 25 °C |     |      | -40 °C to +85 °C |     | -40 °C to +125 °C |     | Unit          |
|-----------------|---------------------------|---|-------|-----|------|------------------|-----|-------------------|-----|---------------|
|                 |                           |   | Min   | Typ | Max  | Min              | Max | Min               | Max |               |
| $I_I$           | input leakage current     | $V_I = 5.5\text{ V}$ or GND; $V_{CC} = 0\text{ V}$ to 5.5 V   | -     | -   | 0.1  | -                | 1.0 | -                 | 2.0 | $\mu\text{A}$ |
| $I_{CC}$        | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0\text{ A}$ ; $V_{CC} = 5.5\text{ V}$   | -     | -   | 2.0  | -                | 20  | -                 | 40  | $\mu\text{A}$ |
| $\Delta I_{CC}$ | additional supply current | per input pin; $V_I = V_{CC} - 2.1\text{ V}$ ; $I_O = 0\text{ A}$ ; other pins at $V_{CC}$ or GND; $V_{CC} = 4.5\text{ V}$ to 5.5 V | -     | -   | 1.35 | -                | 1.5 | -                 | 1.5 | mA            |
| $C_I$           | input capacitance         |   | -     | 3   | 10   | -                | 10  | -                 | 10  | pF            |
| $C_O$           | output capacitance        |   | -     | 4.0 | -    | -                | -   | -                 | -   | pF            |

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**  
 GND = 0 V; For test circuit see [Figure 7](#).

| Symbol                       | Parameter                     | Conditions   | 25 °C          |                    |      | -40 °C to +85 °C |      | -40 °C to +125 °C |      | Unit |
|------------------------------|-------------------------------|--|----------------|--------------------|------|------------------|------|-------------------|------|------|
|                              |                               |  | Min            | Typ <sup>[1]</sup> | Max  | Min              | Max  | Min               | Max  |      |
| <b>For type 74AHC86-Q100</b> |                               |  |                |                    |      |                  |      |                   |      |      |
| $t_{pd}$                     | propagation delay             | nA, nB to nY; see <a href="#">Figure 6</a> <sup>[2]</sup>                    |                |                    |      |                  |      |                   |      |      |
|                              |                               | $V_{CC} = 3.0\text{ V}$ to 3.6 V   |                |                    |      |                  |      |                   |      |      |
|                              |                               | $C_L = 15\text{ pF}$   | -              | 4.8                | 11.0 | 1.0              | 13.0 | 1.0               | 14.0 | ns   |
|                              |                               | $C_L = 50\text{ pF}$   | -              | 6.8                | 14.5 | 1.0              | 16.5 | 1.0               | 18.5 | ns   |
|                              |                               | $V_{CC} = 4.5\text{ V}$ to 5.5 V   |                |                    |      |                  |      |                   |      |      |
|                              |                               | $C_L = 15\text{ pF}$   | -              | 3.4                | 6.8  | 1.0              | 8.0  | 1.0               | 8.5  | ns   |
|                              |                               | $C_L = 50\text{ pF}$   |                | 4.8                | 8.8  | 1.0              | 10.0 | 1.0               | 11.0 | ns   |
| $C_{PD}$                     | power dissipation capacitance | $C_L = 50\text{ pF}$ ; $f_i = 1\text{ MHz}$ ; $V_I = \text{GND}$ to $V_{CC}$ | <sup>[3]</sup> | -                  | 10.0 | -                | -    | -                 | -    | pF   |

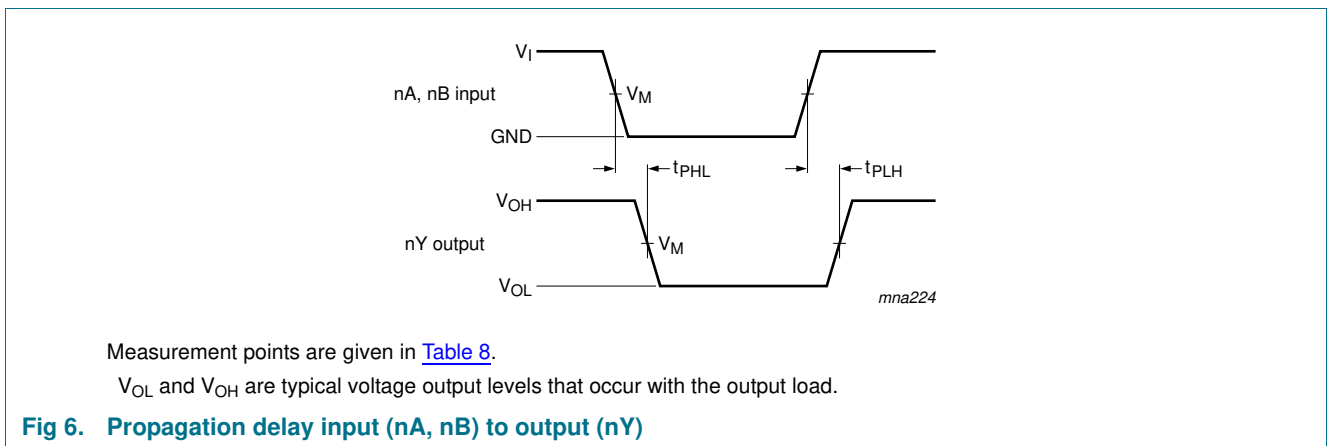


**Table 7. Dynamic characteristics ...continued**  
*GND = 0 V; For test circuit see Figure 7.*

| Symbol                        | Parameter                     | Conditions  | 25 °C |                    |     | -40 °C to +85 °C |      | -40 °C to +125 °C |      | Unit |
|-------------------------------|-------------------------------|---|-------|--------------------|-----|------------------|------|-------------------|------|------|
|                               |                               |   | Min   | Typ <sup>[1]</sup> | Max | Min              | Max  | Min               | Max  |      |
| <b>For type 74AHCT86-Q100</b> |                               |   |       |                    |     |                  |      |                   |      |      |
| $t_{pd}$                      | propagation delay             | nA, nB to nY; see Figure 6 <sup>[2]</sup>   |       |                    |     |                  |      |                   |      |      |
|                               |                               | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$   |       |                    |     |                  |      |                   |      |      |
|                               |                               | $C_L = 15\text{ pF}$  | -     | 3.4                | 6.9 | 1.0              | 8.0  | 1.0               | 9.0  | ns   |
|                               |                               | $C_L = 50\text{ pF}$  | -     | 4.9                | 8.8 | 1.0              | 10.0 | 1.0               | 11.0 | ns   |
| $C_{PD}$                      | power dissipation capacitance | $C_L = 50\text{ pF}; f_i = 1\text{ MHz}; V_i = \text{GND to }V_{CC}$ <sup>[3]</sup> | -     | 12.0               | -   | -                | -    | -                 | -    | pF   |

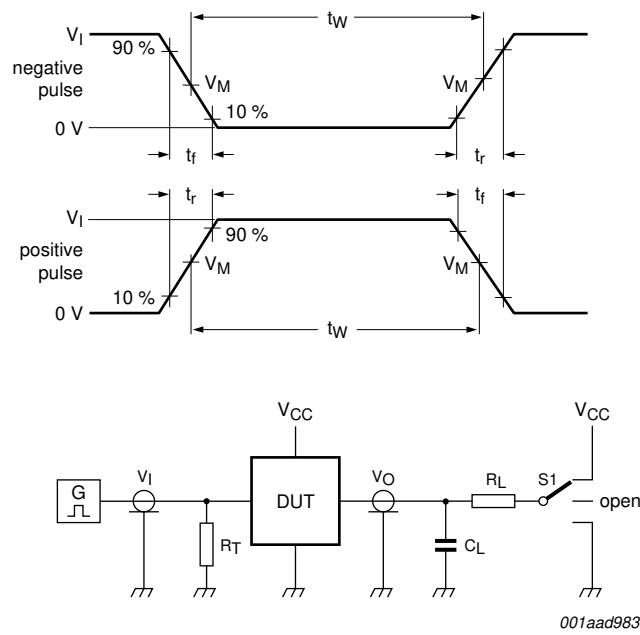
- [1] Typical values are measured at nominal supply voltage ( $V_{CC} = 3.3\text{ V}$  and  $V_{CC} = 5.0\text{ V}$ ).
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:  
 $f_i$  = input frequency in MHz,  $f_o$  = output frequency in MHz  
 $C_L$  = output load capacitance in pF  
 $V_{CC}$  = supply voltage in Volts  
 $N$  = number of inputs switching  
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

## 11. Waveforms



**Table 8. Measurement points**

| Type          | Input       | Output      |
|---------------|-------------|-------------|
|               | $V_M$       | $V_M$       |
| 74AHC86-Q100  | $0.5V_{CC}$ | $0.5V_{CC}$ |
| 74AHCT86-Q100 | 1.5 V       | $0.5V_{CC}$ |



Test data is given in [Table 9](#).

Definitions test circuit:

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator

$C_L$  = Load capacitance including jig and probe capacitance

$R_L$  = Load resistor

S1 = Test selection switch

**Fig 7. Load circuitry for switching times**

**Table 9. Test data**

| Type          | Input    |            | Load         |              | S1 position        |                    |                    |
|---------------|----------|------------|--------------|--------------|--------------------|--------------------|--------------------|
|               | $V_I$    | $t_r, t_f$ | $C_L$        | $R_L$        | $t_{PHL}, t_{PLH}$ | $t_{PZH}, t_{PHZ}$ | $t_{PZL}, t_{PLZ}$ |
| 74AHC86-Q100  | $V_{CC}$ | 3.0 ns     | 15 pF, 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |
| 74AHCT86-Q100 | 3.0 V    | 3.0 ns     | 15 pF, 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

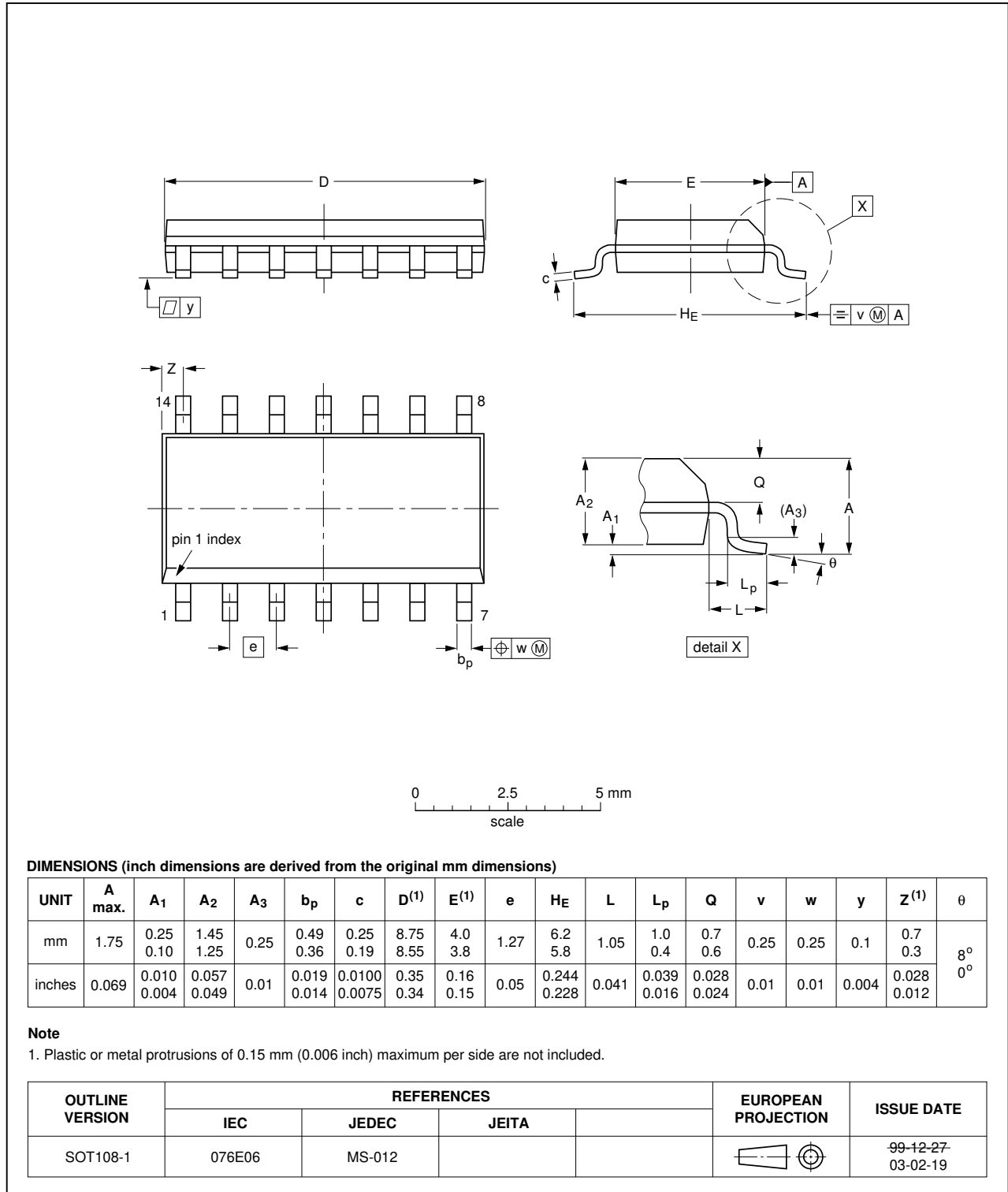


Fig 8. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

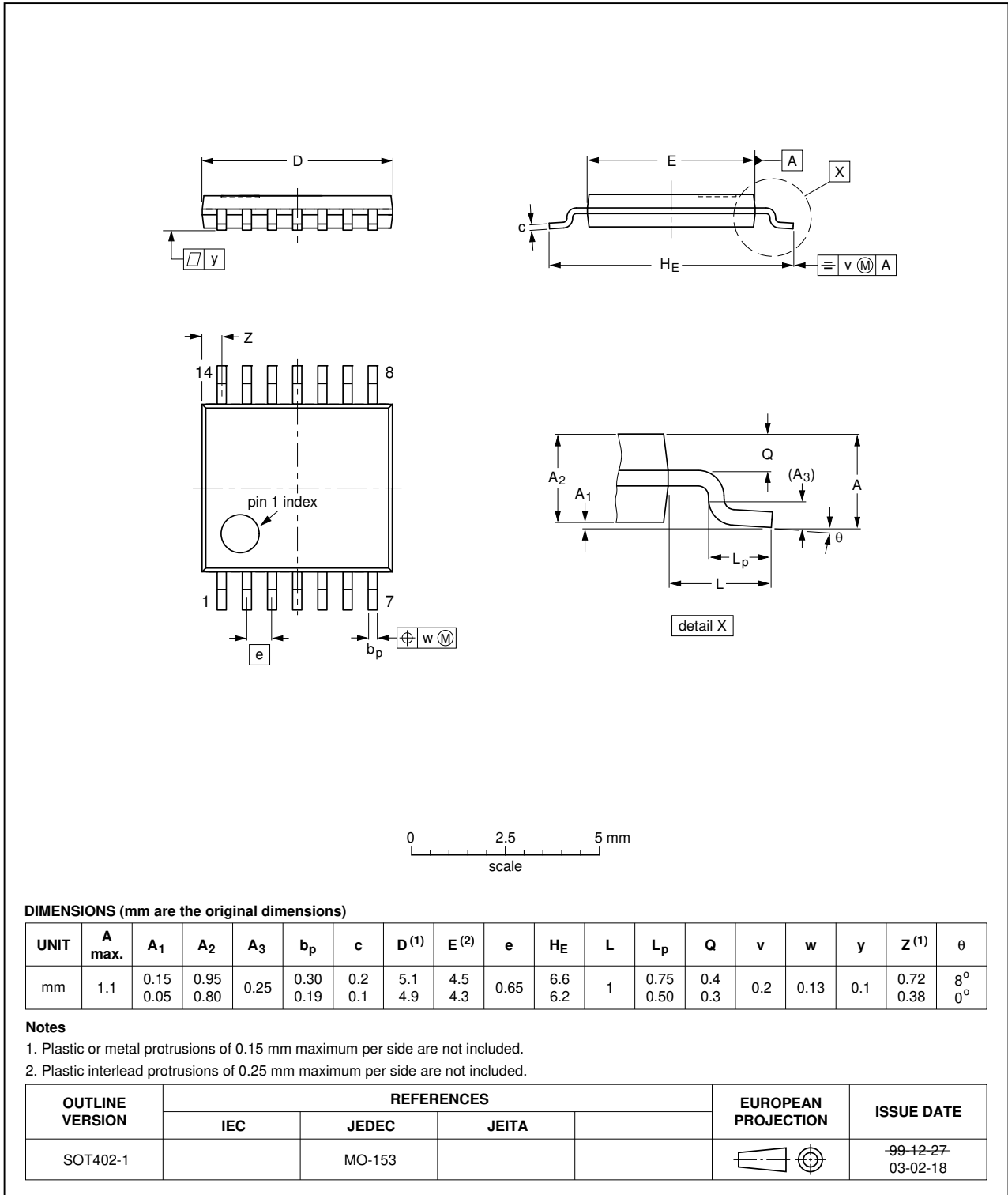


Fig 9. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

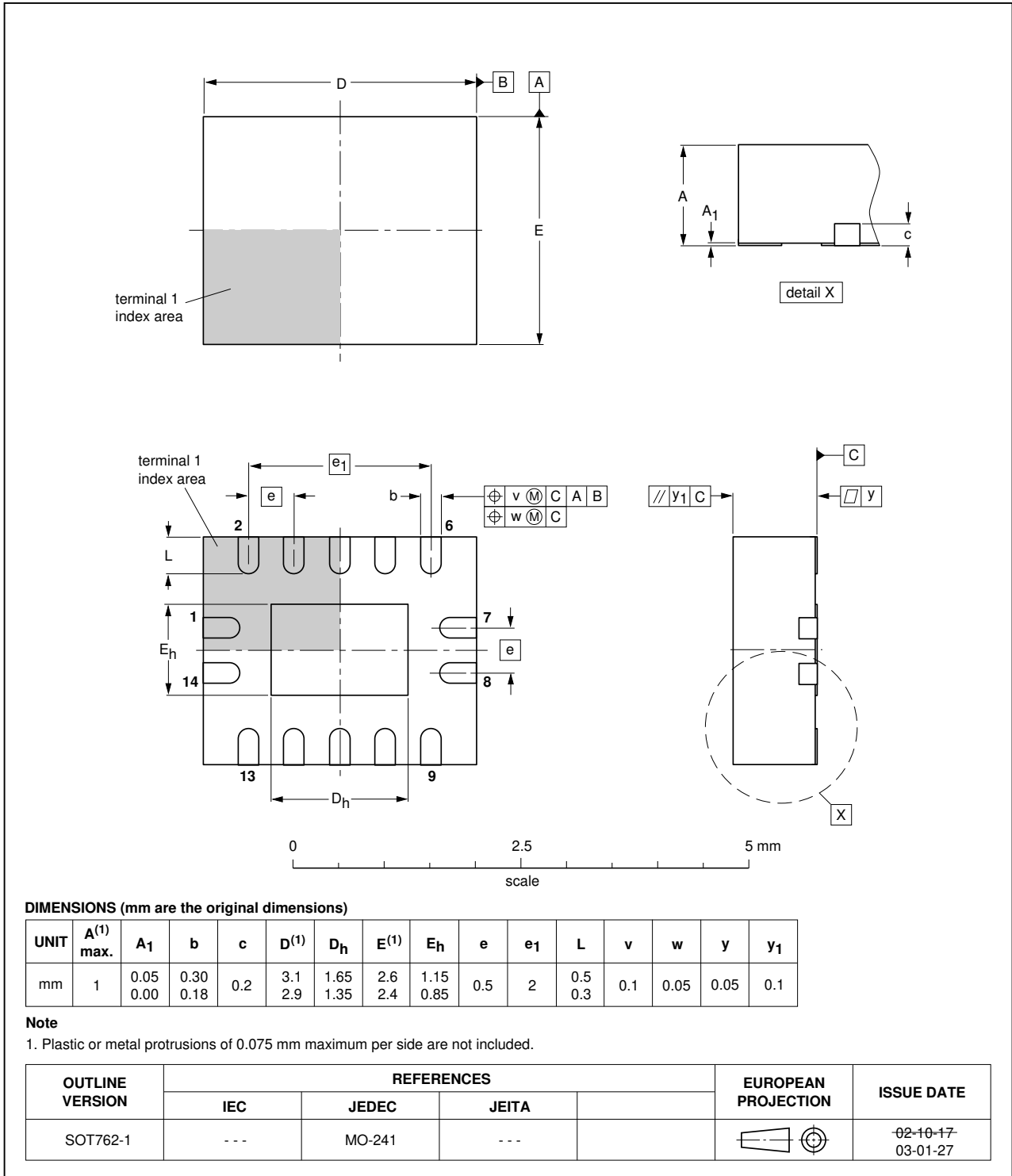


Fig 10. Package outline SOT762-1 (DHVQFN14)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                             |
|---------|---|
| CDM     | Charged Device Model                    |
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MIL     | Military                                |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

## 14. Revision history

Table 11. Revision history

| Document ID           | Release date | Data sheet status  | Change notice | Supersedes |
|-----------------------|--------------|--------------------|---------------|------------|
| 74AHC_AHCT86_Q100 v.1 | 20130605     | Product data sheet | -             | -          |

## 15. Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

### 15.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Short data sheet** — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 15.3 Disclaimers

**Limited warranty and liability** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use in automotive applications** — This NXP Semiconductors product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

**Terms and conditions of commercial sale** — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nxp.com/profile/terms>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

## 15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

## 16. Contact information

---

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)



## 17. Contents

---

|           |   |           |
|-----------|---|-----------|
| <b>1</b>  | <b>General description</b> .....              | <b>1</b>  |
| <b>2</b>  | <b>Features and benefits</b> .....            | <b>1</b>  |
| <b>3</b>  | <b>Ordering information</b> .....             | <b>1</b>  |
| <b>4</b>  | <b>Functional diagram</b> .....               | <b>2</b>  |
| <b>5</b>  | <b>Pinning information</b> .....              | <b>3</b>  |
| 5.1       | Pinning .....                                 | 3         |
| 5.2       | Pin description .....                         | 3         |
| <b>6</b>  | <b>Functional description</b> .....           | <b>3</b>  |
| <b>7</b>  | <b>Limiting values</b> .....                  | <b>4</b>  |
| <b>8</b>  | <b>Recommended operating conditions</b> ..... | <b>4</b>  |
| <b>9</b>  | <b>Static characteristics</b> .....           | <b>5</b>  |
| <b>10</b> | <b>Dynamic characteristics</b> .....          | <b>6</b>  |
| <b>11</b> | <b>Waveforms</b> .....                        | <b>7</b>  |
| <b>12</b> | <b>Package outline</b> .....                  | <b>9</b>  |
| <b>13</b> | <b>Abbreviations</b> .....                    | <b>12</b> |
| <b>14</b> | <b>Revision history</b> .....                 | <b>12</b> |
| <b>15</b> | <b>Legal information</b> .....                | <b>13</b> |
| 15.1      | Data sheet status .....                       | 13        |
| 15.2      | Definitions .....                             | 13        |
| 15.3      | Disclaimers .....                             | 13        |
| 15.4      | Trademarks .....                              | 14        |
| <b>16</b> | <b>Contact information</b> .....              | <b>14</b> |
| <b>17</b> | <b>Contents</b> .....                         | <b>15</b> |

---

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

---

© NXP B.V. 2013.

All rights reserved.

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)

Date of release: 5 June 2013

Document identifier: 74AHC\_AHCT86\_Q100